



SCREEN CLEANER

SYS-CLEAN SCC1.0 is a solvent based cleaning medium for cleaning SMT stencils and screens with water-soluble emulsions. **SYS-CLEAN SCC1.0** cleans reliable solder pastes, SMT adhesives, thick film pastes and conductive adhesives from stencils and screens in explosion-proof equipment. Due to the high flashpoint, the use in screen printers and machines is also possible.

Application

Pollution	Suitability
Solder pastes	✓✓
SMT adhesives and conductive adhesives	✓✓
Thick film pastes	✓✓
Misprints	✓

Application Parameters

Parameter	
Application temperature	20°C
Cleaning duration approx	5-8min.
Rinsing	SCC2.0
Drying	Compressed Air
Application concentration	Ready to use

Specifications

SYS-CLEAN SCC1.0 is supplied as ready to use mixture.

Density	0,891g/cm ³
Vapor pressure at 20°C	ca. 13hPa
Autoflammability	not self-igniting
Flashpoint	45°C
pH value	4,6



SYS-CLEAN SCC1.0

Advantages: **SYS-CLEAN SCC1.0** is due to its high flashpoint used easily without external explosion protection in explosion-protected spray cleaning systems.

An additional filtering extends the very good bath life time.

SYS-CLEAN SCC1.0 can be dried well and helps optimize the process with its short cleaning time.

Safety: Please note the information in the MSDS.

Disposal: If required, we will take back used medium and undertake the disposal for you.

Availability: **SYS-CLEAN SCC1.0** is available in pack sizes of 25 or 200 liters.



The product is free of questionable ingredients in accordance with the SIN & SVHC lists



100% compliant with the EU RoHS directive 1 & 2, WEEE